BEANS

Hetero-functional Integrated Device Technology Development



Bio Electro-mechanical Autonomous Nano Systems

BEANS Laboratory
The University of Tokyo
Kyushu University
Ritsumeikan University
Advanced Industrial Science and Technology



MEMS Future = BEANS

- In Japan, we say semiconductor chips are rice for the industry.
- Rice provide energy for the body.

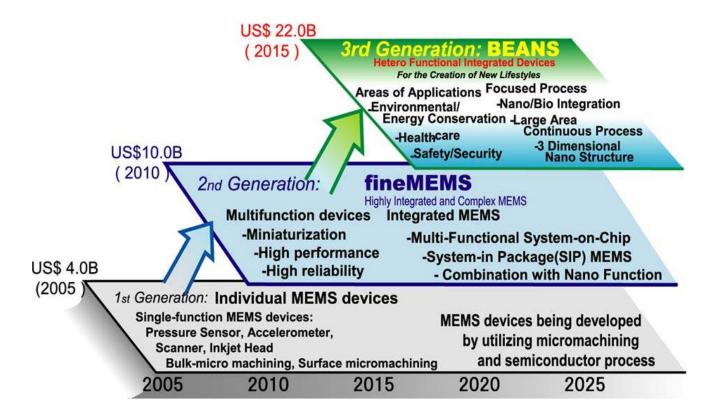


 Beans contain proteins for bio functions, such as eyes for sensing and muscle for actuation. We hope MEMS to be beans for the industry.

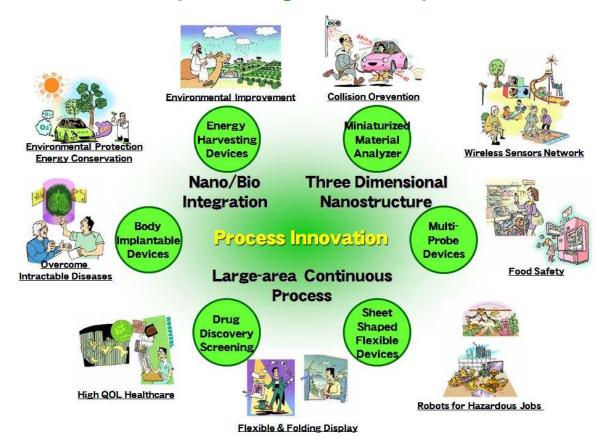


Fujita, Int. Sympo. Micromachine/Nanotech '07

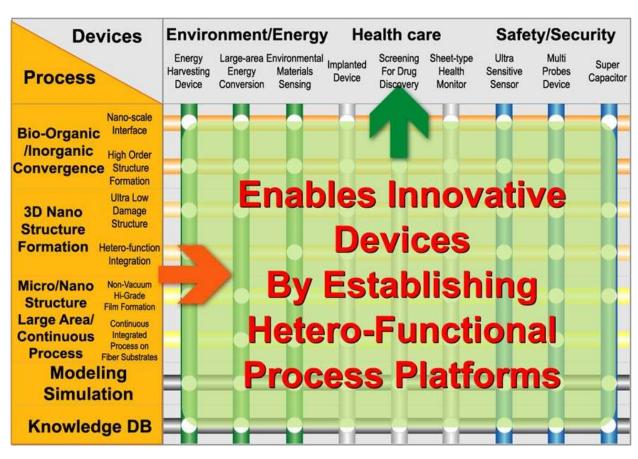
MEMS Technology & Market Development Roadmap



New Lifestyles being Enabled by **BEANS**



Target of BEANS Project



Categories & Subjects of BEANS

1 Bio/Organic Materials Integration Process

- ◆Nano-scale Interfaces Treatment
- ◆Bio/Organic Integrated Higher-Order Structure Formation

2 Novel fabrication technology for 3-D Nano-structures

- ◆Top-down fabrication of monolayer-flat, defect-free 3D structure
- ◆Bottom-up technology for heterogeneous integration of materials and functions on 3-D platform
- ◆3-D nano-fabrication for aerospace applications

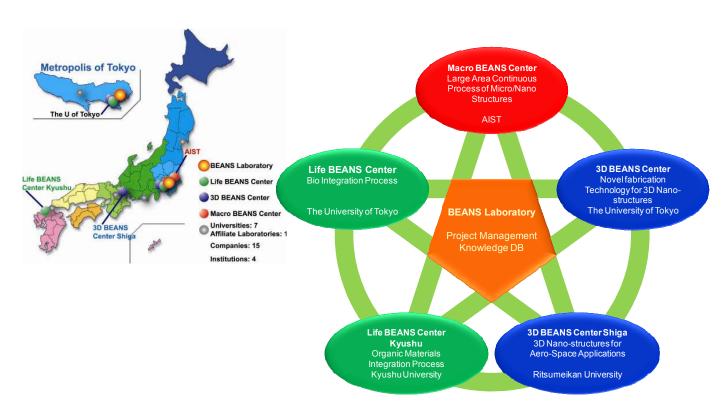
3 Large Area Continuous Process of Micro/Nano Structure

- ◆Non-vacuum large-area deposition techniques of high-quality nano/micro materials
- ◆Continuous nano/micro -machining and integration Process for fiber substrates

4 Building up of Knowledge Database

in Heterogeneous Technology Convergence Process Development

BEANS Research Initiative



Project Leader: Atsushi YUSA

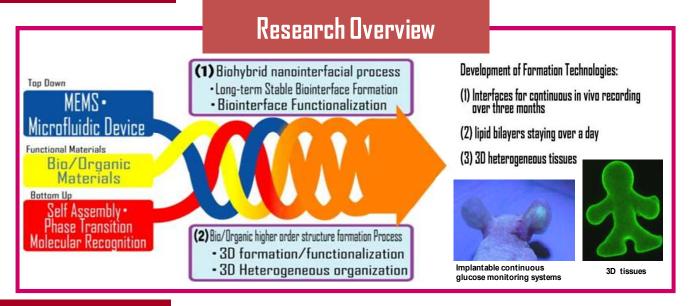
① -A Bio Materials Integration Process : Life BEANS Center

S.Takeuchi, Univ. of Tokyo

Market, Social Needs Technology Requirements

Health, Medicine ⇒ Implantable Device,
Highly Sensitive Chemical Sensors

Environment ⇒ Energy Harvesting Device Harnessing Bio and Organic materials for MEMS

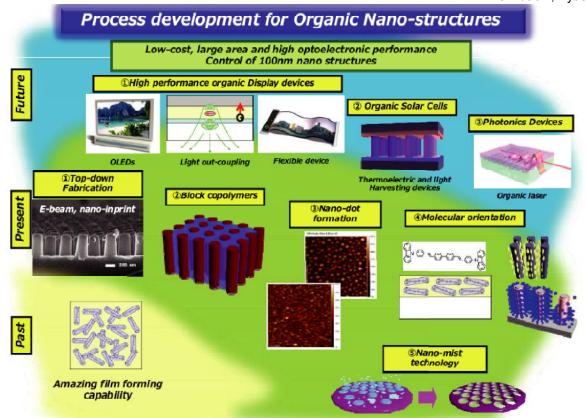


Impacts
Applications

- Implantable glucose sensors
- Single molecular Level, Ultra highly sensitive chemical sensors
- Sensors for drug kinetics with minimal load of animal experiments

(1) -B Organic Materials Integration Process : Life BEANS Center Kyushu Nano-Process Technology Enables Innovative Organic Devices

C.Adachi, Kyushu Univ.



② Novel fabrication technology for 3-D nano-structures: 3D BEANS Center

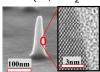
Needs

Sensor network for safe, secured and healthy life High-sensitivity sensing, energy harvesting, high-density recording

M. Sugiyama, Univ. of Tokyo

Seeds

A monolayer-flat, defect-free 3D structure (Si, SiO₂ etc...)





(1) Top-down fabrication of monolayer-flat, defect-free 3D structure

Research items

- Neutral beam etching
- Nano-domain modification by fs-laser

Surface functionalization by foreign materials and nano-structures







on 3-D platform Supercritical-fluid deposition and coating

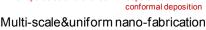
Assembly of nanoparticles, nanodots and nanotubes on 3-D platforms

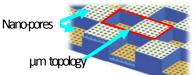
(2) Bottom-up technology for heterogeneous

integration of materials and functions



- Nano-structure imprint on a 3-D microstructure
- Filters for multi-band selection





Applications



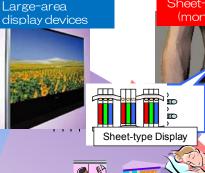
Simulation, nano-tribology

Sheet-type health-care

Super-capacitors, Ultra-high-sensitivity sensors, Tbit/cm2 recording, nmresolution high-throughput lithography, Multiband-spectroscopy from space

3 Large Area Continuous Process of Micro/Nano Structure: Macro BEANS Center





T. Itoh. AIST

Ultrasonic wave sending

and receiving electrode

Piezoelectric thin film

Wearable energy

Ultrasonic Probe Sheet

Meter-size devices

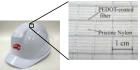
To develop new fabrication process which deposits high quality nano/micro materials on meter-size substrate without vacuum process equipment

Flexible sheet-type devices

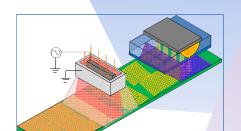
To develop new fabrication process that realizes flexible sheet-type large-area devices utilizing micromachining and weaving integration of fiber substrates instead of micromachining of large substrates

harvesting devices

Smart jackets for safety and security



Flexible touch sensor



Non-vacuum large-area deposition techniques of high quality nano/micro materials

Continuous nano/micro-machining and integration process for fiber substrates

Outcome of 2008

| Item | Headquarter | Life BEANS Center | Life BEANS Center Kyushu | 3D BEANS Center | 3D BEANS Center Shiga | Macro BEANS Center | Total |
|----------------------------|-------------|----------------------|--------------------------------|--------------------|-----------------------------|--------------------------|--------|
| Patents | 0 | 1+(3) | 4+(2) | (1) | 2 | 3+(2) | 10+(8) |
| Press Release | 3 | 2 | 0 | 0 | 3 | 0 | 8 |
| Publications Conference | 7 | 11 | 2 | 3+(7) | 0 | 4 | 27+(7) |
| Publications Journal | 0 | (1) | 2 | 0 | 0 | 0 | 2+(1) |

()under Applications

BEANS Laboratory

| Ectablish | March 24 2000 | |
|-----------|---------------|--|

Mission • Executing BEANS Project (Hetero-functional Integrated device Technology Development Project)

•Sending researchers who are assigned from the member companies of BEANS Laboratory to BEANS

Centers, and collaborating with researchers of universities and National Institutes

Chairperson Hisao SAKUTA
Executive Director Keiichi AOYAGI

Director Atsushi YUSA (Project Leader)

Members 20 Organizations (Companies and Institutions) as of July, 2009

DENSO Corp. FUJI Electric Systems Co., Ltd. FUJUKURA Ltd.

FURUKAWA Electric Co., Ltd. LINTEC Corp. Mathematical Systems, Inc.

MITSUBISHI Chemical Medience Corp. MITSUBISHI Electric Corp.

MIZUHO Information & Research Institute, Inc. OLYMPUS Corp.

OMRON Corp. PANASONIC Electric Works, Ltd. SEIKO Instruments Inc.

TERUMO Corp. TOSHIBA Corp. TOSHIBA Machine Corp.

Institute for Unmanned Space Experiment Free Flyer

Institute of System, Information Technologies and Nanotechnologies
Japan Resources Observation System & Space Utilization Organization

Micromachine Center

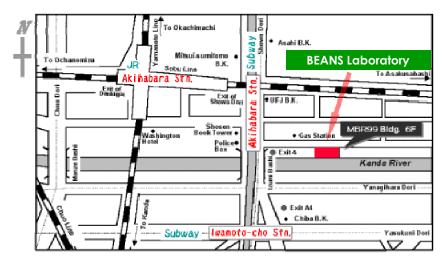
Number of researchers 81 (Including affiliates)

BEANS Center Life BEANS Center, 3D BEANS Center: Institute of Industrial Science, The University of Tokyo

Life BEANS Center Kyushu: Center for Future Chemistry, Kyushu University

3D BEANS Center Shiga: Ritsumeikan University

Macro BEANS Center: Advanced Industrial Science and Technology



BEANS Laboratory

http://www.beanspj.org/lab/